

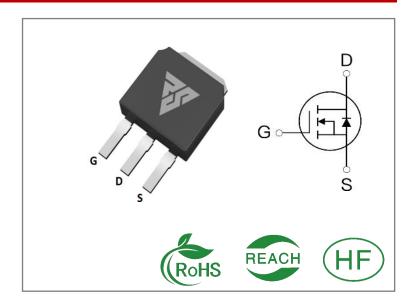
ID	R _{DS} (ON)(Typ)	VDSS
4A	2Ω	650V

Applications:

- Switch Mode Power Supply(SMPS)
- Adapter & Charger
- AC-DC Switching Power Supply

Features:

- Fast switching speed
- 100% avalanche tested
- Improved dv/dt capability



Ordering Information

Part Number	Package	Marking	Packing	Qty.
RS4N65MD	T0-251	RS4N65MD	Tube	80 PCS

Absolute Maximun Ratings Tc= 25 ℃ unless otherwise specified

Symbol	Parameter	RS4N65MD	Units
VDSS	Drain-to-Source Voltage	650	V
ID	Continuous Drain Current TC=25°C	4	^
IDM	Pulsed Drain Current (Note*1)	16	A
PD	Power Dissipation	107	W
VGS	Gate- to- Source Voltage	±30	V
EAS	Single Pulse Avalanche Engergy L = 10mH, VDD = 50V, RG = 25 Ω	80	mJ
	Maximum Temperature for Soldering	300	
TL TPKG	Leads at 0.063in(1.6mm)from Case for 10 seconds	260	${\mathbb C}$
	Package Body for 10 seconds		
TJ and	Operating Junction and Storage	-55 to 150	
TSTG	Temperature Range	33 (0130	

^{*} Drain Current Limited by Maximum Junction Temperature

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" Table may cause permanent damage to the device.



Thermal Resistance

Symbol	Parameter	RS4N65MD	Units	Test Conditions
				Drain lead soldered to water cooled
RθJC	Junction-to-Case	1.16		heatsink, PD adjusted for a peak
			°C/W	junction temperature of + 1 5 0 $^{\circ}{\mathbb{C}}$
RθJA	Junction-to-	90		1 cubic fact chamber free air
KOJA	Ambient	80		1 cubic foot chamber,free air.

OFF Characteristics TJ= 25° C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BVDSS	Drain- to- source Breakdown Voltage	650			V	VGS=0V,ID=250μA
IDSS	Drain- to- Source Leakage Current			1	μΑ	VDS=650V,VGS=0 V
	Gate- to- Source Forward Leakage			100		VGS=30V ,VDS=0V
IGSS	Gate- to- Source Reverse Leakage			-100	nA	VGS=-30V ,VDS=0 V

ON Characteristics TJ=25 °C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Мах.	Units	Test Conditions
RDS(on)	Static Drain- to- Source On- Resistance(Note*2)		2	2.4	Ω	VGS=10V,ID=2A
VGS(TH)	Gate Threshold Voltage	3		4	V	VGS=VDS,ID=250μ A

Resistive Switching Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
td(ON)	Turn- on Delay Time		36			
trise	Rise Time		13			VDS=325V
td(OFF)	Turn- OFF Delay Time		80		nS	ID=4A RG=25Ω
tfall	Fall Time		24			



Dynamic Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Ciss	Input Capacitance		543			VGS=0V
Coss	Output Capacitance		53		pF	VDS=25V
Crss	Reverse Transfer Capacitance		4.5			f=1.0MHz
Qg	Total Gate Charge		15			VDS=520V
Qgs	Gate- to- Source Charge		3		nC	ID=4A
Qgd	Gate-to-Drain(" Miller") Charge		7			VGS=10V

Source-Drain Diode Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
IS	Continuous Source Current			4	Α	Integral pn- diode
ISM	Maximum Pulsed Current			16	Α	in MOSFET
VSD	Diode Forward Voltage			1.4	٧	IS=2A,VGS=0V
trr	Reverse Recovery Time		550		nS	VGS=0V
Qrr	Reverse Recovery Charge		1.38		μC	IS=2A,di/dt=100A/ μs

Notes:

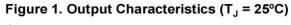
^{* 1.} Repetitive rating, pulse width limited by maximum junction temperature.

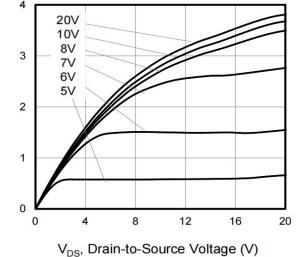
^{* 2.} Pulse Test: Pulse width ≤ 300µs, Duty Cycle ≤ 1%



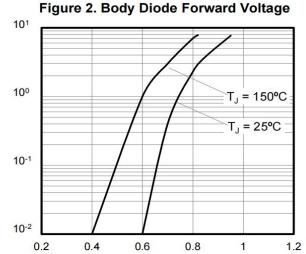
Typical Feature Curve

I_D, Drain Current (A)





ls, Source Current (A)



P_D, Power Dissipation (w)

Figure 3. Drain Current vs. Temperature

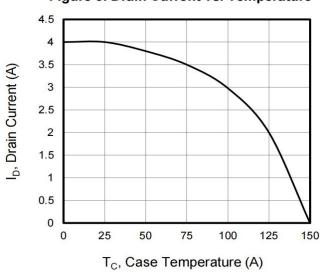


Figure 4. BV_{DSS} Variation vs. Temperature

V_{SD}, Source-to-Drain Voltage (V)

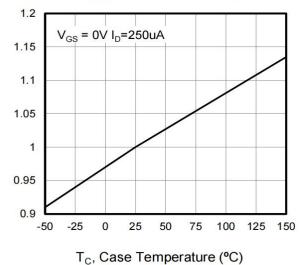
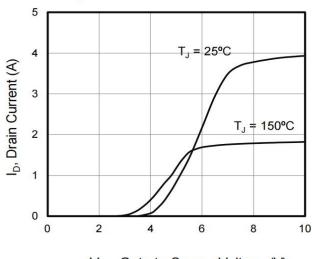
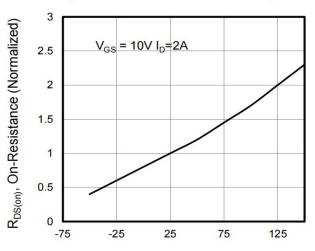


Figure 5. Transfer Characteristics



V_{GS}, Gate-to-Source Voltage (V)

Figure 6. On-Resistance vs. Temperature



T_J, Junction Temperature (°C)

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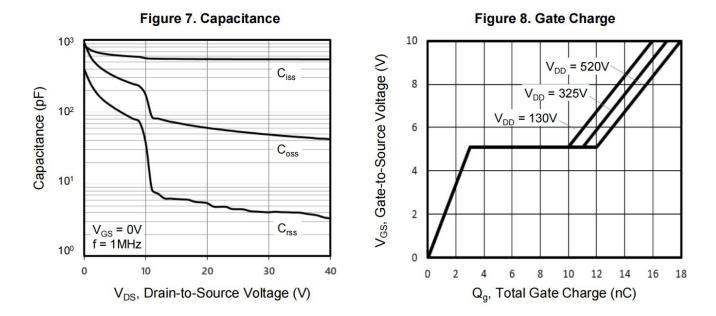
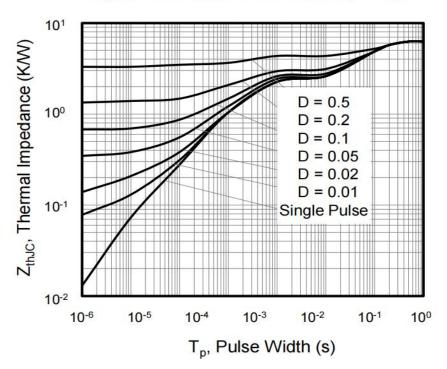


Figure 9. Transient Thermal Impedance



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Test Circuits and Waveforms

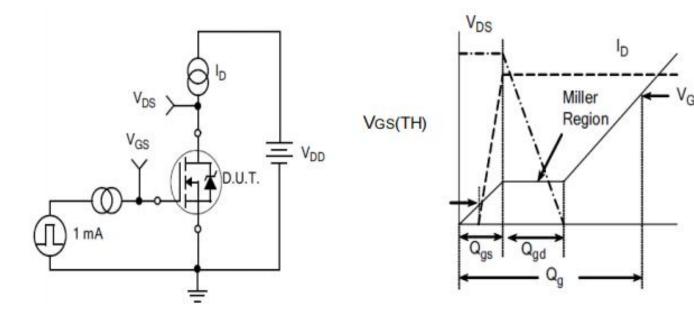


Figure 10.
Gate Charge Test Circuit

Figure11.
Gate Charge Waveform

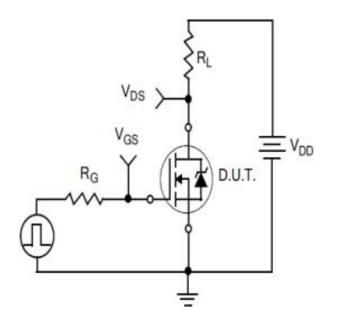


Figure12.
Resistive Switching Test Circuit

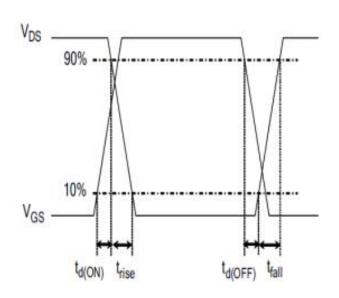


Figure 13.
Resistive Switching Waveforms



Test Circuits and Waveforms

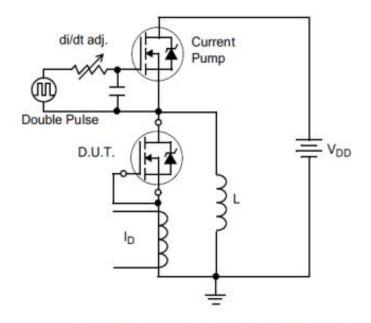


Figure 14. Diode Reverse Recovery
Test Circuit

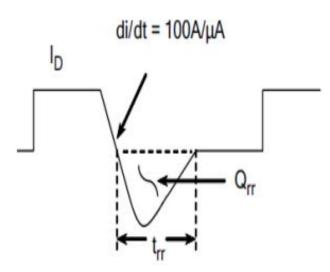


Figure 15. Diode Reverse Recovery Waveform

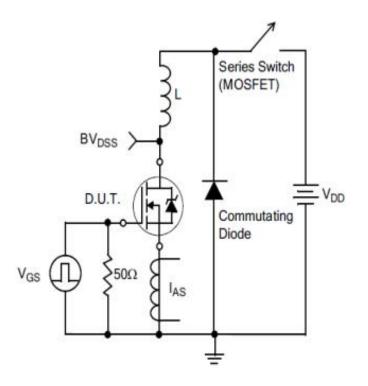
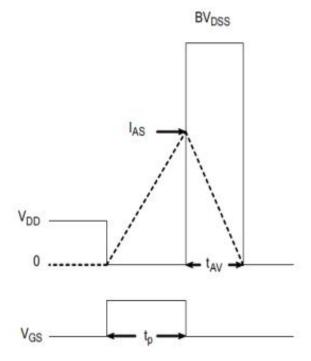


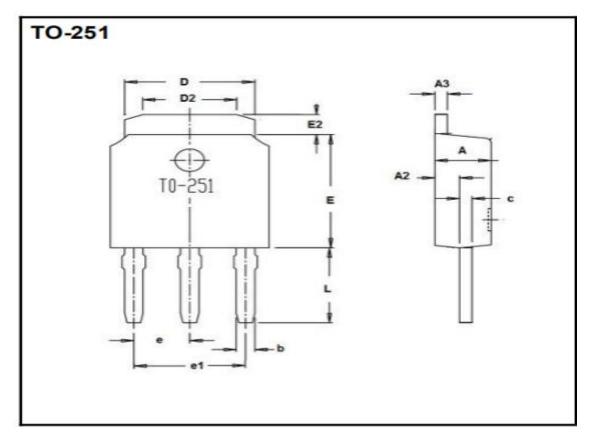
Figure 16. Unclamped Inductive Switching Test Circuit



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Package outline drawing(TO-251 Unit: mm)



Dim.	Min.	Max		
Α	2.15	2.45		
A2	0.9	1.1		
A3	Typ0.5			
b	0.74 0.86			
С	0.9	1.1		
D	5.33	5.53		
D2	3.65	4.05		
E	6.0	6.2		
E2	0.91	1.36		
е	Тур	2.29		
e1	Typ4.58			
L	3.7	4.3		



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